



4 Diode Currents

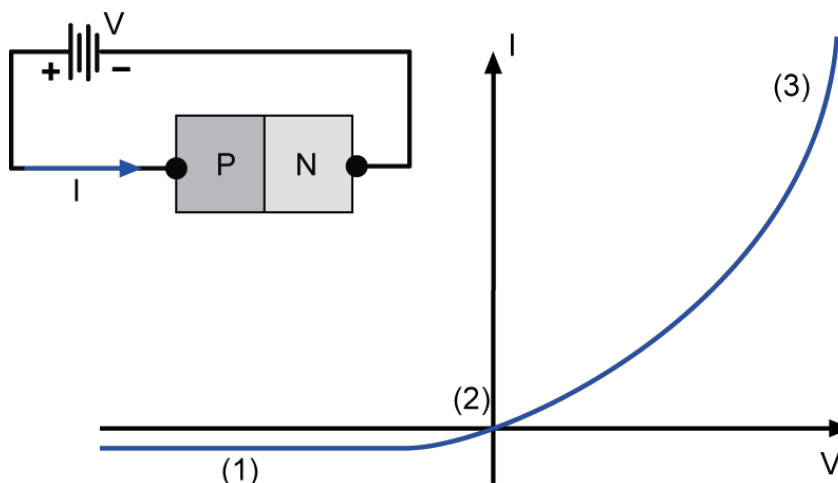
Name: _____ Complete _____

Reminders

- (1) ★ will mark areas where we will stop until we agree upon the solution as a group, or until I check your answer. If your group gets done early, then you may move onto problems near the end that we might not complete during class.
- (2) When you are done and I have approved, erase all your work on the wall/board. Clean up! No food or drink other than water please.

In-Class Problems

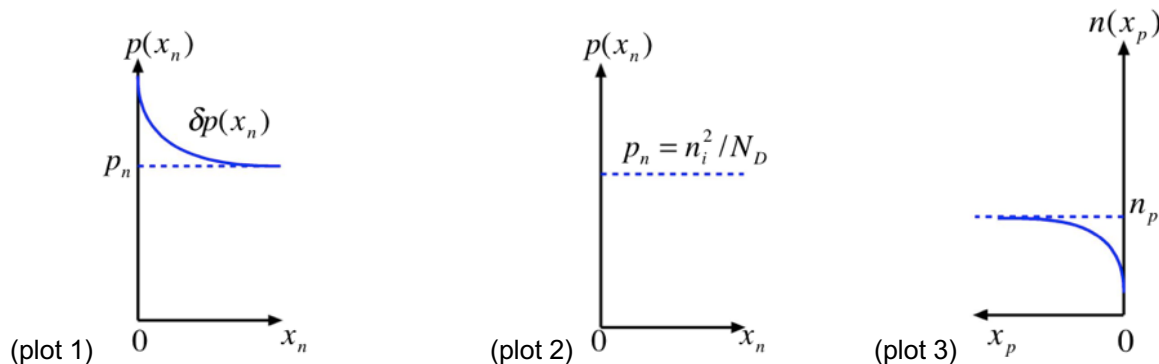
(1) The I-V diagram of an ideal PN junction is shown at right. For each of the three points labeled on the curve (1, 2, 3) provide the following:



- (a) a simplified version of the diode equation for each point
- (b) band-diagram showing with where the current components originate from
- (c) a short description of the forces that drive each current component, and which current component dominates (if any)

★

(2) Below is a plot of carrier concentration on either side of a diode, under various bias conditions. You should be able to answer these questions and fully understand them!



(a) the three plots

- ___ are for minority carriers ONLY
- ___ are for majority carriers ONLY
- ___ include both

(b) label each item below as plot 1, plot 2, or plot 3:

- ___ an excess at the depletion edge ($X=0$) because of forward bias and diffusion
- ___ zero concentration at the depletion edge ($X=0$) because of reverse bias and drift
- ___ no concentration change because drift and diffusion currents balance at 0V for a diode ★

(3) You increase doping for a diode, the how does the FORWARD current change and WHY. Don't just refer to the equation, explain it based on drift/diffusion, generation, energy barriers, etc. ONE SENTENCE MAX!

(4) You increase doping for a diode, the how does the REVERSE current change and WHY. Don't just refer to the equation, explain it based on drift/diffusion, generation, energy barriers, etc. ONE SENTENCE MAX!

★

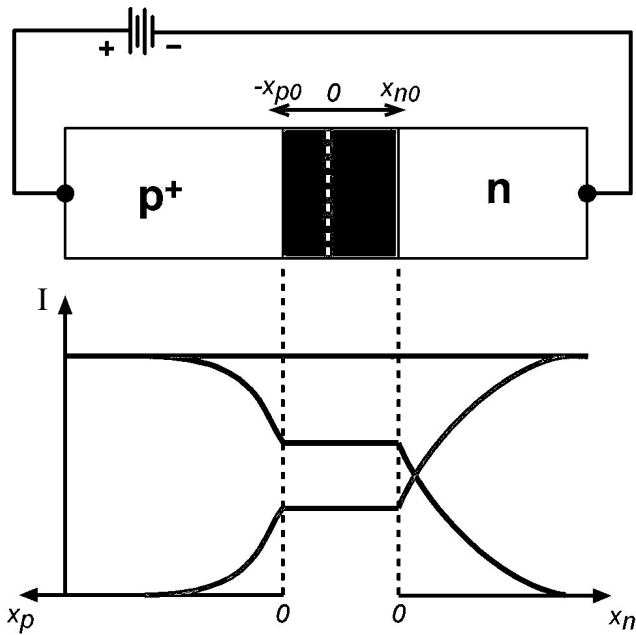
(5) [20 pts] An ideal Si p+n junction at 300K has the following parameters (you may or may not need them all).

<u>p-side:</u>	<u>n-side:</u>	<u>General parameters</u>
$N_a=10^{17}/\text{cm}^3$	$N_d=10^{15}/\text{cm}^3$	$A=10^{-4} \text{ cm}^2$
$D_n=18 \text{ cm}^2/\text{sec}$	$D_p=25 \text{ cm}^2/\text{sec}$	$\epsilon_{\text{Si}}=11.8$
$L_n=10^{-3} \text{ cm}$	$L_p=10^{-2} \text{ cm}$	

- (a) What is the drift current across the junction at an applied reverse bias of -3V?
- (b) What is the diffusion current across the junction at a reverse bias of -3V? ★
- (c) What is the diffusion current across the junction at a forward bias of 0.7? V?
- (d) What is the drift current across the junction at a forward bias of 0.7? V? ★

Extra Problems (if you have time, finish during class when I can help, or on your own time)

(6) Two-part question related to this plot of hole current, electron current, and total current. First, why are the electron and hole currents not constant in the p-type and n-type regions? Second, why are they constant inside the depletion region?



(7) Why does the ideal diode equation give constant current under reverse bias? 1-2 sentences MAX.

(8) Use MATLAB to visualize effects of doping on diode current (from Pierret Ex. 6.5). Play around with the code a bit. When you enter doping levels at the "ND=" prompt, put the input in square brackets and separated by spaces (1D array of data). A useful range may be several values from 1e+16 to 1e+17 for doping.

```
%Variation of Ideal-Diode I-V with semiconductor
doping.
%Si step junction, T = 300K.
%In response to the "ND=" prompt type [ND1 ND2 ...] to
input
%multiple doping values.
%Initialization and Universal Constants
clear

k=8.617e-5;
q=1.6e-19;
%Device, Material, and System Parameters
A=1.0e-4;
ni=1.0e10;
taup=1.0e-6;
ND=input('Input the n-side doping concentration, ND = ');
T=300;
%Hole Mobility Calculation
NAref=2.35e17;
upmin=54.3;
up0=406.9;
ap=0.88;
up=upmin+up0./(1+(ND./NAref).^ap);
%The mobility calculation here assumes the hole
minority carrier
%mobility is equal to the hole majority carrier mobility.
%I-V Calculation
VA=linspace(-1,0.2);
DP=k.*T.*up;
LP=sqrt(DP.*taup);
```

```
I0=q.*A.*(DP./LP).*(ni^2 ./ND)
I=I0.*(exp(VA./(k.*T))-1);
%Plotting Result
close
plot(VA,I); grid;
ymin=-2*I0(1); ymax=5*I0(1);
axis([-1,0.2,ymin,ymax]);
xlabel('VA (volts)'); ylabel('I (amps)');
%Adding axes,key
xx=[-1 0.2]; yx=[0 0];
xy=[0 0]; yy=[ymin,ymax];
hold on
plot(xx,yx,'-w',xy,yy,'-w');
j=length(ND);
for i=1:j;
    yput=(0.70-0.06*i)*ymax;
    yk(i,1)=yput; yk(i,2)=yput;
    text(-0.68,(0.69-
0.06*i)*ymax,['ND=',num2str(ND(i)),'/cm3']);
end
xk=[-0.8 -0.7];
plot(xk,yk);
text(-0.74,0.75*ymax,'Si, 300K');
hold off
```

EECS 2077
Semiconductor
Devices

